L Number	Hits	Search Text	DB	Time stamp
1	0	661/233.ccls.	USPAT;	2003/11/04 14:14
			US-PGPUB	2003/11/04 14:14
2	248	361/233.ccls.	USPAT;	2003/11/04 14:14
			US-PGPUB	2003/11/04 14:14
3	493	361/234.ccls.	USPAT:	2003/11/04 14:15
			US-PGPUB	2003/11/04 14.13
4	57709	force near2 (sens\$3 detect\$3 control\$3	USPAT;	2003/11/04 14:15
		monitor\$2)	US-PGPUB	2003/11/04 14.15
5	28	361/234.ccls. and (force near2 (sens\$3	USPAT;	2003/11/04 14:15
		<pre>detect\$3 control\$3 monitor\$2))</pre>	US-PGPUB	2003/11/04 14:15
6	328	361/235.ccls.	USPAT;	2003/11/04 14:15
			US-PGPUB	2003/11/04 14.15
7	2595	electrostatic near2 chuck	USPAT;	2003/11/04 14:16
			US-PGPUB	2000, 22, 01 21.10
8	93	(force near2 (sens\$3 detect\$3 control\$3	USPAT;	2003/11/04 14:16
		monitor\$2)) and (electrostatic near2	US-PGPUB	= 0 0 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
		chuck)		
9	2376	(electrostatic near2 chuck) and (workpiece	USPAT;	2003/11/04 14:16
		wafer)	US-PGPUB	
10	115	((electrostatic near2 chuck) and	USPAT;	2003/11/04 14:18
		(workpiece wafer)) and current near2	US-PGPUB	
		(detect\$3 sens\$3 monitor\$2)		
11	1095	(electrostatic near2 chuck) and plasma	USPAT;	2003/11/04 14:17
		near2 process	US-PGPUB	
12	64	((electrostatic near2 chuck) and plasma	USPAT;	2003/11/04 14:18
	·	near2 process) and current near2 (detect\$3	US-PGPUB	
1.0		sens\$3 monitor\$2)	i	
13	377	(electrostatic near2 chuck) and wafer same	USPAT;	2003/11/04 14:18
		(dechuck\$2 releas\$2)	US-PGPUB	
14	334	279/128.ccls.	USPAT;	2003/11/04 14:29
1.5	100	000 (000	US-PGPUB	
15	182	279/128.ccls. and (electrostatic near2	USPAT;	2003/11/04 14:29
1.6		chuck)	US-PGPUB	
16	19	279/128.ccls. and (force near2 (sens\$3	USPAT;	2003/11/04 14:29
		<pre>detect\$3 control\$3 monitor\$2))</pre>	US-PGPUB	